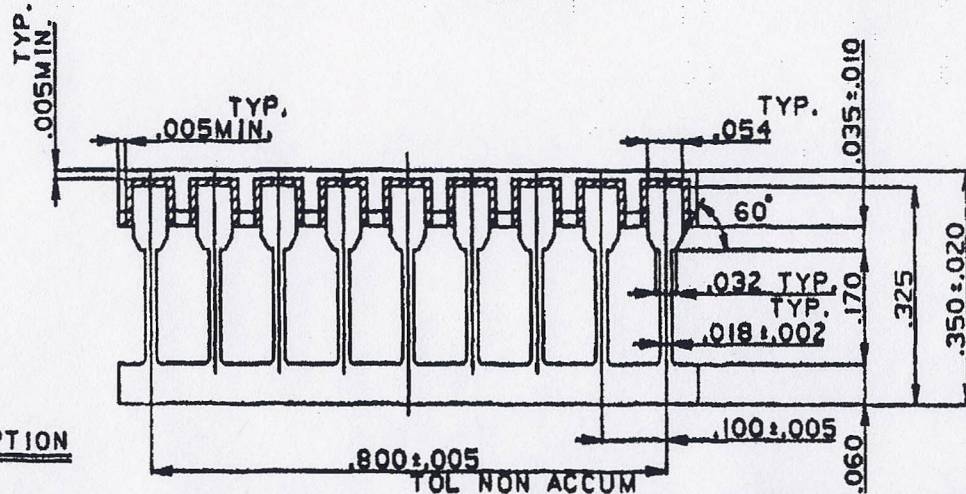


DETAIL - A

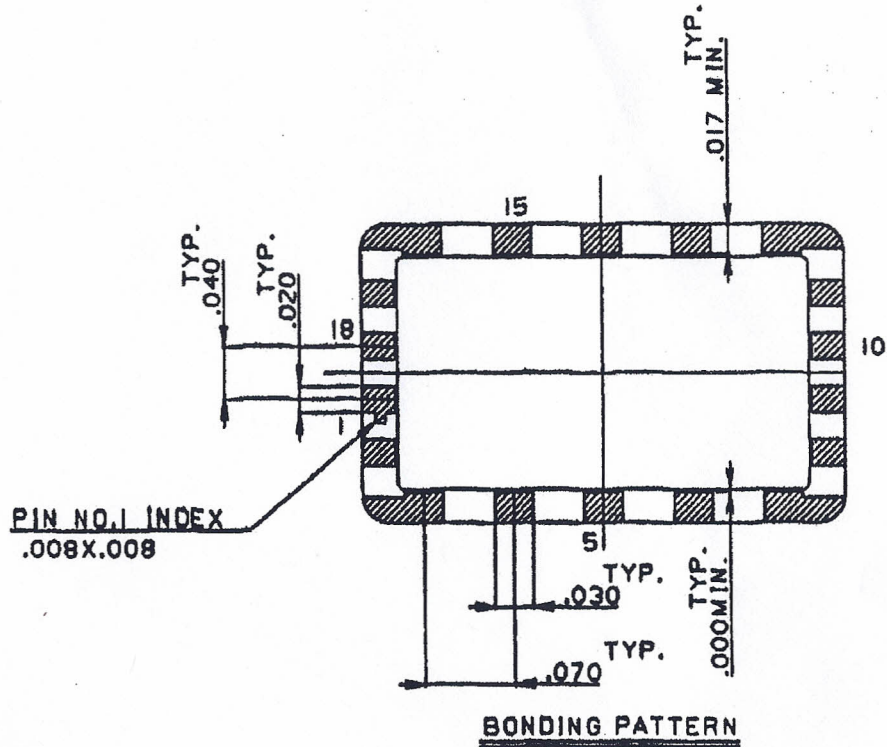
NOTES


1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
2. SEAL AREA TO BE METALLIZED.
3. DIE ATTACH AREA TO BE METALLIZED.
4. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.
5. LEAD RESISTANCE : 0.200 MAX.



SB018T600-1 S:0 D:0

MODIFICATION	NAME	18 LEAD SIDE BRAZED PACKAGE		TOLERANCE	UNLESS OTHERWISE SPECIFIED		DRAWN	CHECKED	APPROVED	DATE
	SCALE	5/1		MATERIAL	AS INDICATED		H.Y	K.O	M.M	JUL 24.87
	CHANGED	DATE	DRAWN	CHECKED	APPROVED	THIRD ANGLE PROJECTION				
							DRAWING NO.	KD-587600		SHEET
							KYOCERA CORPORATION KYOTO JAPAN			1/2



MODIFICATION					NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
					18 LEAD SIDE BRAZED PACKAGE	UNLESS OTHERWISE SPECIFIED	H.Y	K.O	M.M	JUL.24.87
					SCALE 10/1	MATERIAL				
	CHANGED	DATE	DRAWN	CHECKED	APPROVED	 KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO.		OFF 1	
							KD-S87600		2/2	